Applicabl	e standard							
• •	Operating temperature range Operating humidity range Voltage Applicable Connector		-35°C to +85°C(Not	Í	Storage temperature range	·	-10°C to +60°C(Note3)	
Rating					Storage humidity range	· ·	40 % to 70 %(Note3)	
			150 V AC (DC))	Current	1 A	1 A	
			DF13-*S-1.25		Applicable Contact	` ,	DF13(G)-2630SCF DF13-3032SCF	
			Spe	cification	ns			
It	em		Test method			Requirements	QT	АТ
Construc	tion	•					•	
General examination		Visually and by measuring instrument.			According to dra	According to drawing.		
Marking		Confirmed visually.						
Electric o	haracteris	tics						
Contact resistance		100 m A (100 m A (DC or 1000 Hz).			30 mΩ MAX.		
Insulation rea	sistance	100 V DC.			500 MΩ MIN.	500 MΩ MIN.		
Voltage proo	f	500 V AC for 1 min.			No flashover or	No flashover or breakdown.		
Mechani	cal charac	teristics						
Mechanical operation		30 times insertions and extractions.				 Contact resistance: 30 mΩ MAX. No damage, crack or looseness of parts. 		
Vibration		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 2 h, for 3 directions.				 No electrical discontinuity of 1μs. No damage, crack or looseness of parts. 		
Shock		490 m/s ² directions	duration of pulse 11 ms at 3 ti	imes for 3				
Environn	nental cha	racterist	ics					
Rapid change of temperature Damp heat		Temperature -55 \rightarrow 15 to 35 \rightarrow +85 \rightarrow 15 to 35 °c Time 30 \rightarrow 2 to 3 \rightarrow 30 \rightarrow 2 to 3 min. Under 5 cycles. Exposed at 40 \pm 2 °c, 90 to 95 %, 96 h.			② Insulation re	① Contact resistance: 30mΩ MAX. ② Insulation resistance: 500 MΩ MIN. ③ No damage, crack or looseness of parts.		
(Steady state	e)						X	
Resistance to soldering heat		1) Reflow soldering ≪ Reflow area ≫ 250°C MAX 10 sec MAX 230°C MIN 60 sec MAX ≪ Preheating area ≫ 170°C to 190°C 60 sec to 120 sec Put through in reflow furnace twice, leave in ambient temperature and humidity for 1 hour. 2) Manual soldering Soldering iron temperature :300°C, Soldering time : 3sec. No strength on contact.				No deformation of case of excessive looseness of the terminals.		
Solderability		Soldered at solder temperature, 245°c for insertion duration, 3sec.				Solder shall cover a minimum of 95 % of the surface being immersed.		
Note 2:No cor Note 3:Apply t after p	e the temperatur ndensing to the condition of oct on board, op therwise s	of long term serating temp	urrent. storage for unused products before and humidity range is ap refer to IEC 60512. on of revisions	plied for interin		ortation. Checked	Date	
		Cooriptii	C. C. TOVIOIOIIG		,o.g.rod	CHOOKOU	Date	

Oi	11033 0111	erwise specific, refer to IEC 60312.						
	Count	t Description of revisions		Designed			Checked	Date
					Ар	proved	KI. AKIYAMA	16. 01. 21
					Ch	necked	TS. FUKUSHIMA	16. 01. 21
					Designed		YK. YAMAGUCHI	16. 01. 21
					D	rawn	MI. SAKIMURA	16. 01. 21
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			Drawing no.		g no.	ELC-367983-21-00		
HS.		Specification sheet			ırt no.	DF13E-*DP-1. 25V(21)		21)
1.0	.)	Hirose electric co., ltd.			de no.	e no. CL536		<u>^</u> 1/1